



#### Advanced Process

Powerful enough for the Simple enough for ever

### **Recipe Control**

#### **Every aspect of your process; One unified recipe**

Pre-deposition I wafer prep, source ramp-up, & stabilization
Layer control I thickness, rate, shuttering, & source idling

Stage control I heating, cooling, rotation, angle, & biasing

Gas & pressure I pressure stability & precise gas delivery

Automation I press start & leave the system to do everything

Process is Ro

Process is Ro

Process is Ro

Rock

Main

Process is Ro

Process i

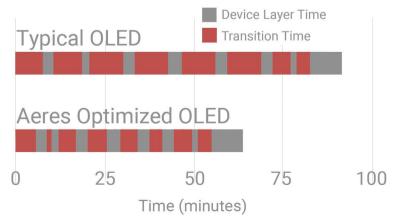
Create processes as simple or as complex as desired

Use the pre-loaded templates, or build custom sequences from scratch

Build recipes from a remote PC, then seamlessly transfer the recipe over to the deposition tool PC for use Can run entirely autonomously, or you can build manual control into recipes if desired

The unified data management system collects & logs all pertinent process information

## Layer Transition Efficiency



45% reduction in layer transition time 30% improvement in total device fabrication time

## Total device time is dramatically reduced due to parallel task management

Parallel task management is the automatic and simultaneous control of background processing. It includes source preparation, mask & sample transferring, power & temperature ramping, & stage preparation, which greatly reduces transition times between layers.

## Control Software most advanced user. ery user in the lab.



### **Features**

#### **Modern User-Interface**

Built on .NET framework and is SECS/GEM ready Runs on Windows® PC, and is touch-screen compatible Enabled for multiple-user profiles with administrator control Complete & thoroughly tested safety & interlock system

#### **Multi-Chamber Capable**

Single terminal can control multiple chambers, each with unique recipes

#### **Process control hardware integration**

QCM monitoring and control
End point detection using reflection/transmission or ellipsometry
In situ plasma monitoring

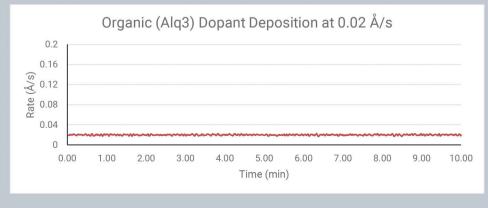
The Angstrom team will provide process support, training, and troubleshooting remotely, or in-person

## **Advanced Deposition Control**

Aeres allows our partners to achieve unprecedented low-rate stability

User adjustable PID detection algorithm (advanced auto-tuning)

Significantly reduce your process development time



Actual stability while depositing a common OLED material (Alq3) at 0.02 Å/s

# Aeres and all of its features available across our deposition platforms



#### Service and Support: Our Commitment

An Angstrom system in your lab makes us partners; we become part of your team.

We guarantee **same day** response to any service inquiry regarding parts, technical support, and software support.

